



1/7

FIG.1

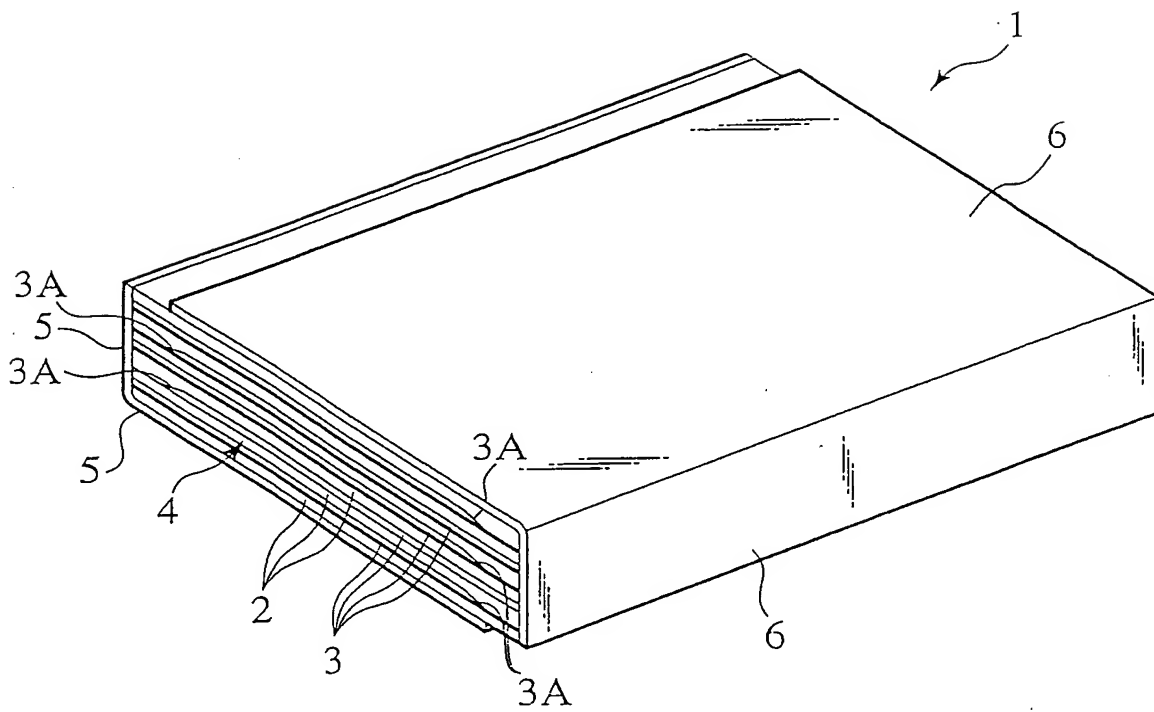


FIG.2

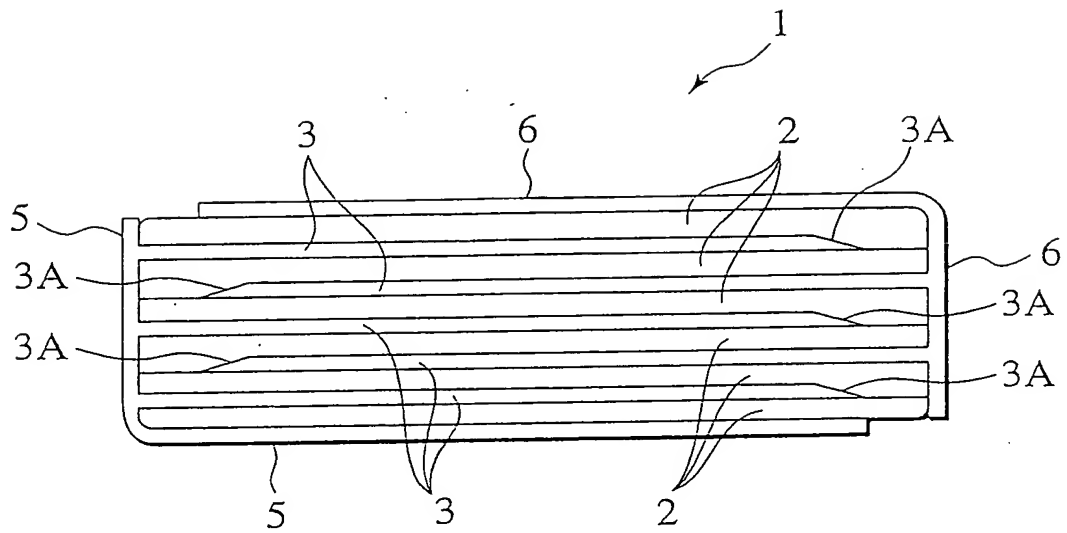


FIG.3

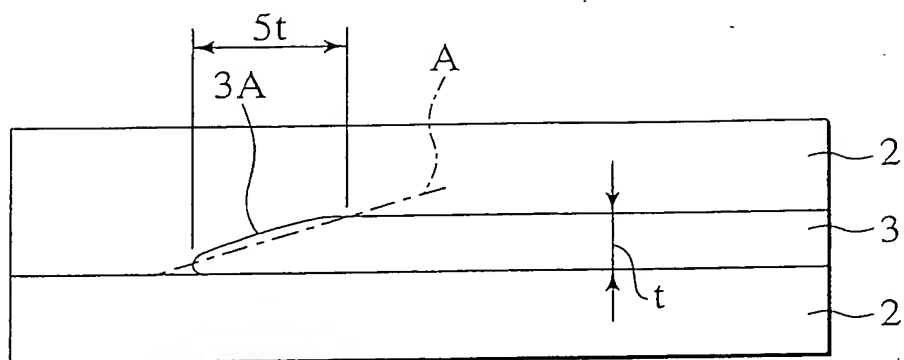


FIG.4

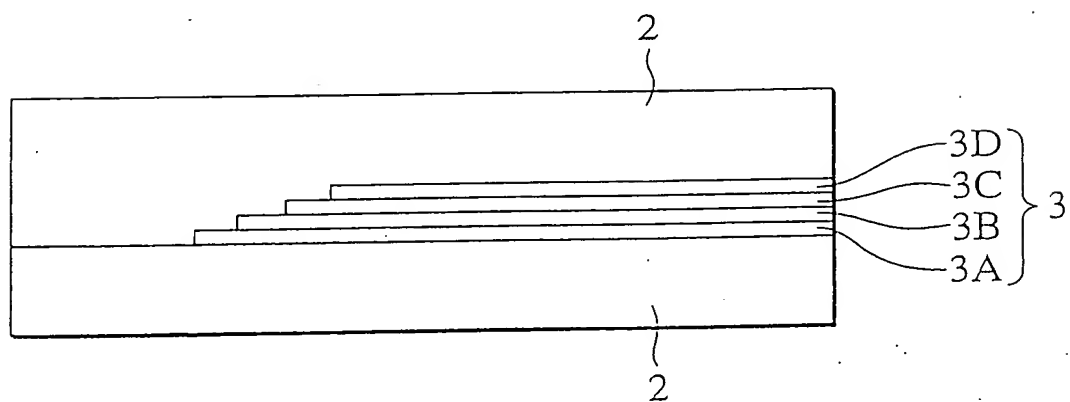


FIG. 5

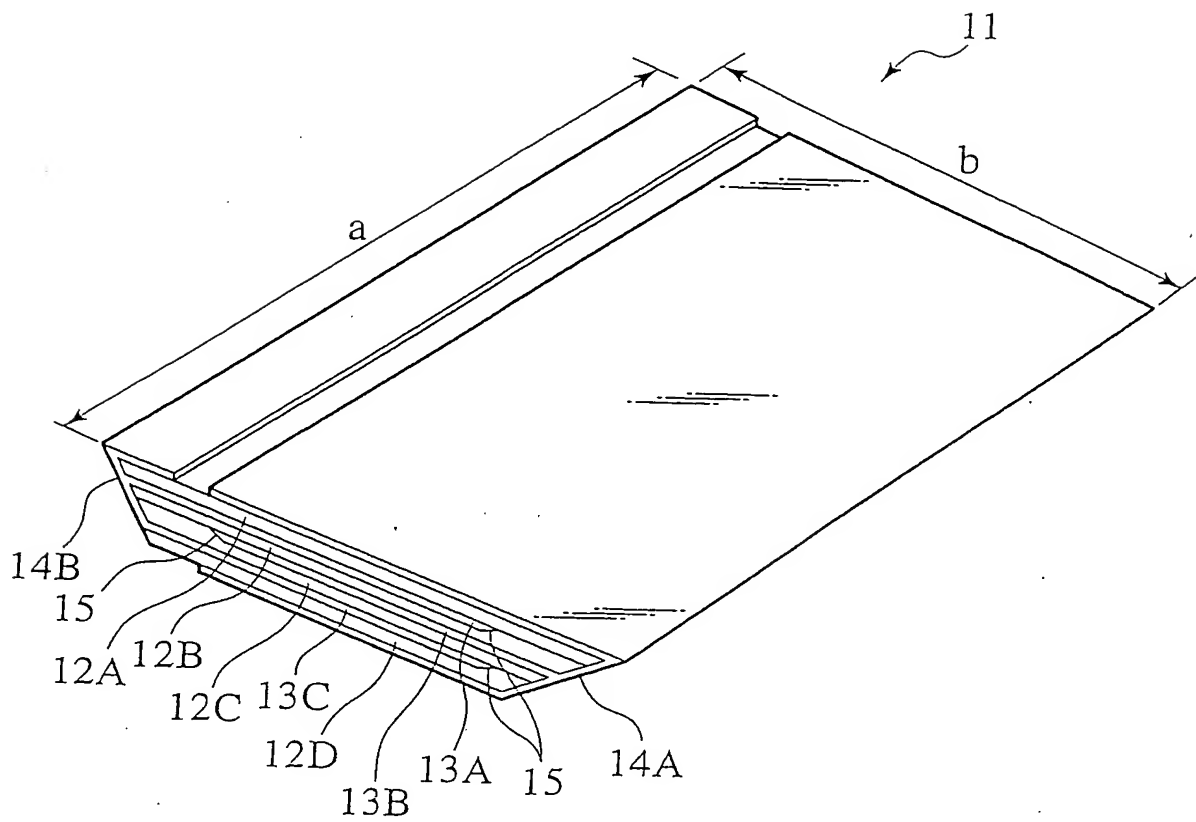


FIG. 6

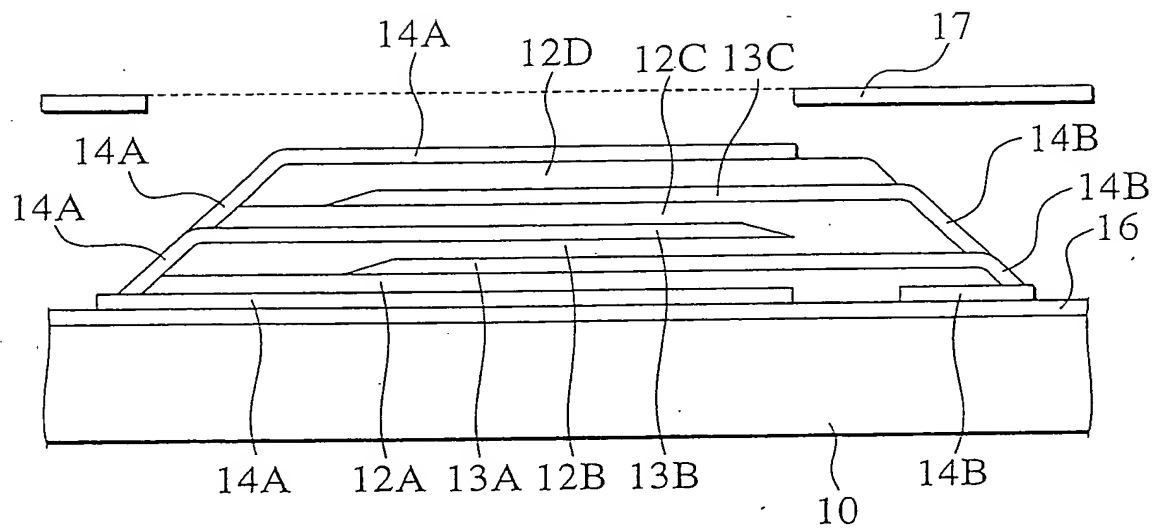


FIG. 7

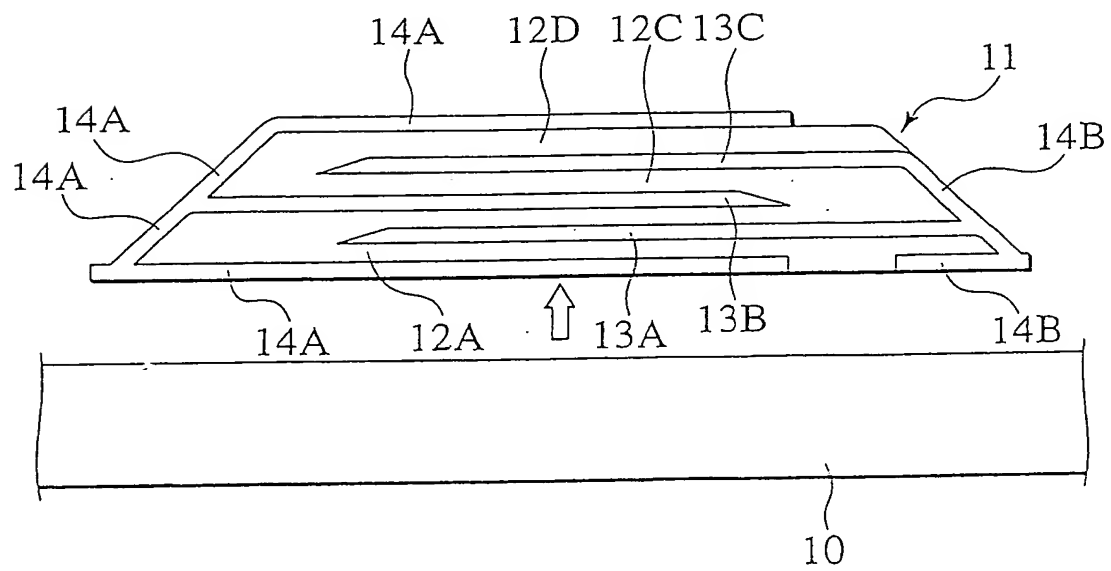


FIG.8

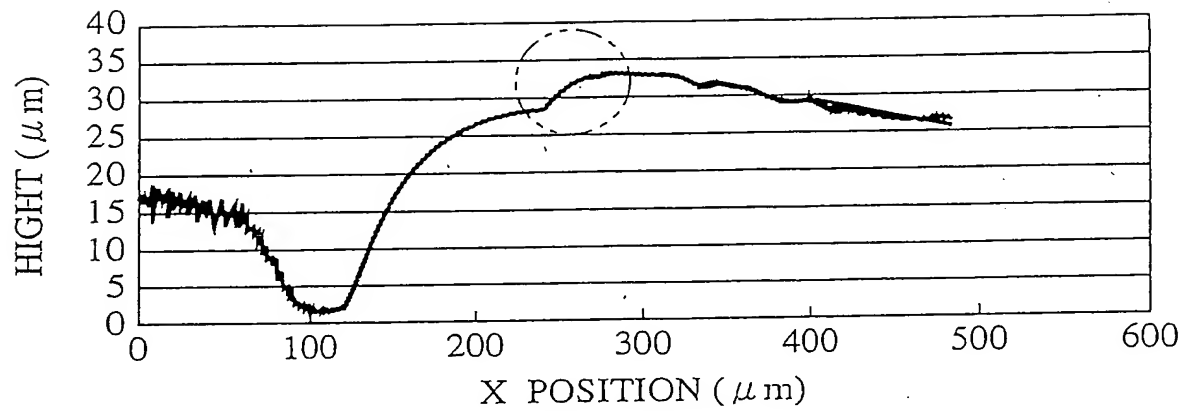


FIG.9

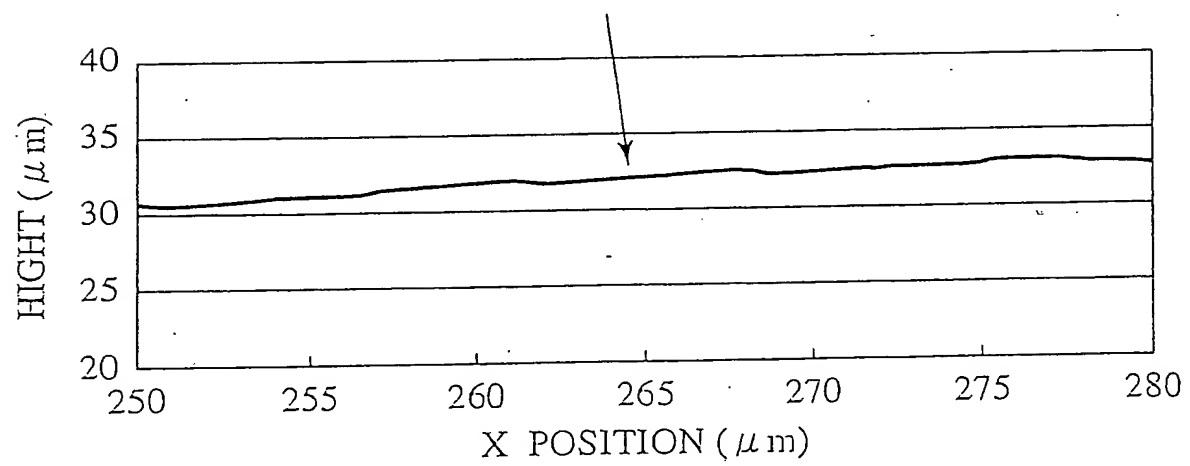


FIG.10

ELECTRODE PASTE PARTICLE DIAMETER, MEAN (μm)	ELECTRODE PASTE BINDER, PART (wt%)	ELECTRODE PASTE SOLVENT, PART (wt%)	ELECTRODE PASTE VISCOSITY (Pa \cdot sec)	NONFIRED CERAMIC LAYER SURFACE ROUGHNESS (Ra, μm)	ELECTRODE ANGLE (deg.)
0.050	5.0	10	4200	0.3	35
4.5	5.0	10	50	0.3	1.7
1.5	5.0	25	25	0.3	1.4
1.5	5.0	4.0	3300	0.3	33
1.5	5.0	10	300	0.3	14
1.5	0.7	10	32	0.3	1.8
1.5	12	10	3100	0.3	32

FIG.11

PIEZOELECTRIC / ELECTROSTRICTIVE PASTE		NONFIRED CERAMIC LAYER SURFACE ROUGHNESS (Ra, μm)	ELECTRODE PASTE VISCOSITY (Pa \cdot sec)	ELECTRODE ANGLE (deg.)
POWDER PARTICLE DIAMETER, MEDIAN (μm)	BINDER, PART (wt%)			
0.050	5.0	0.090	300	5.0
5.2	5.0	0.60	300	31
0.50	31	0.060	300	3.0
0.50	0.4	0.70	300	33
0.50	5.0	0.10	300	6.0
0.50	5.0	0.60	300	32